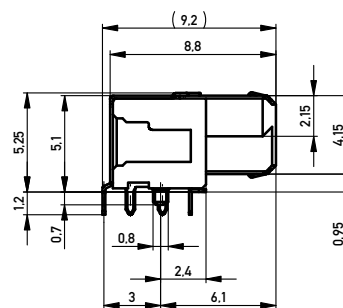
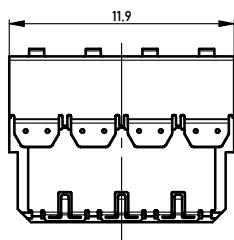
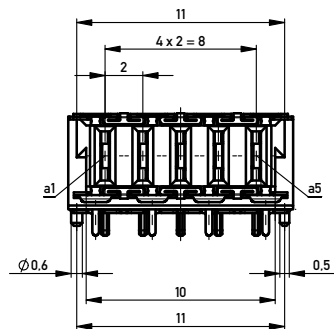
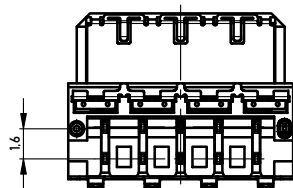
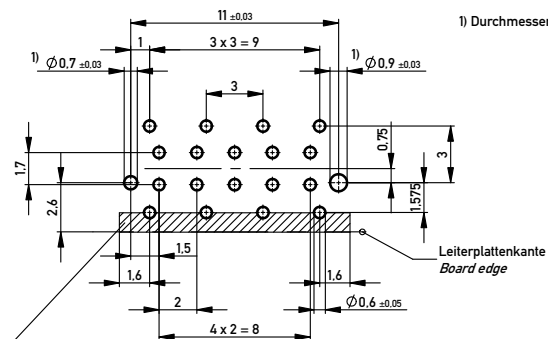




Leiterplatten-Layout Vorschlag / PCB-layout proposal

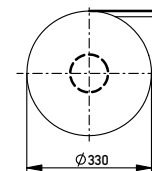


1) Durchmesser des Bohrers / Drill tool

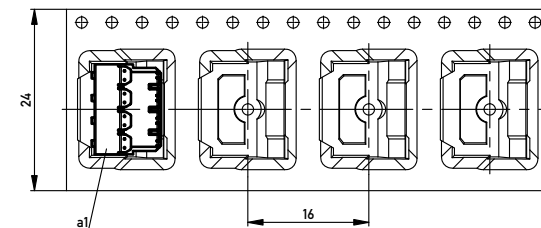
Leiterplattenkante
Board edge

Schirmblechauflagefläche berücksichtigen,
keine Durchkontaktierungen oder Leitungen möglich!
Consider shielding contact area, no vias or traces possible!

Verpackt im Gurt in Anlehnung an DIN IEC 60286-3
Tape on Reel Packaging according to DIN IEC 60286-3
Verpackungseinheit: 500 Stück
Packaging unit: 500 pcs



Abspulrichtung - Reel off Direction



Anforderungsstufe 1
Performance Level 1

Kontaktbereich vergoldet
Mating Area gold plating

Anschlussbereich verzinkt 4-6 µm
Terminal Area 4-6 µm tin plating

Information:			Tolerances		 All Dimensions in mm		Scale		5:1			
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							MSpeed Federl. 90° PM THR <i>MSpeed female 90° PM THR</i>					
			 www.ERNI.com				394571				I A2	
Index		27.05.2015						Class		MSPPM		

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